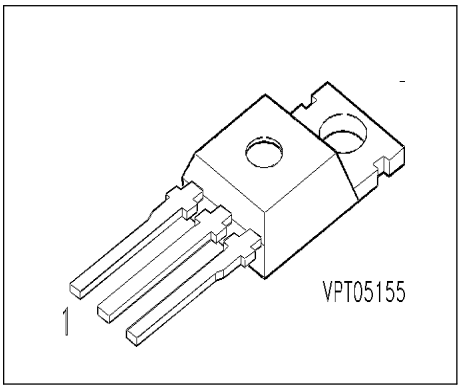
IGBT

Preliminary data

- Low forward voltage drop
- High switching speed
- Low tail current
- Latch-up free
- Avalanche rated



Pin 1	Pin 2	Pin 3
G	C	E

Type	V_{CE}	I_C	Package	Ordering Code
BUP 213	1200V	32A	TO-220 AB	Q67040-A4407-A2

Maximum Ratings

Parameter	Symbol	Values	Unit
Collector-emitter voltage	V_{CE}	1200	V
Collector-gate voltage R_{GE} = 20 kΩ	V_{CGR}	1200	
Gate-emitter voltage	V_{GE}	± 20	
DC collector current T_C = 25 °C T_C = 90 °C	I_C	 32 20	A
Pulsed collector current, t_p = 1 ms T_C = 25 °C T_C = 90 °C	I_{Cpuls}	 64 40	
Avalanche energy, single pulse I_C = 15 A, V_{CC} = 50 V, R_{GE} = 25 Ω L = 200 µH, T_j = 25 °C	E_{AS}	 22	mJ
Power dissipation T_C = 25 °C	P_{tot}	 200	W
Chip or operating temperature	T_j	-55 ... + 150	°C
Storage temperature	T_{stg}	-55 ... + 150	

Maximum Ratings

Parameter	Symbol	Values	Unit
DIN humidity category, DIN 40 040	-	E	-
IEC climatic category, DIN IEC 68-1	-	55 / 150 / 56	

Thermal Resistance

IGBT thermal resistance, chip case	R_{thJC}	≤ 0.63	K/W

Electrical Characteristics, at T_j = 25 °C, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Static Characteristics					
Gate threshold voltage	$V_{GE(th)}$				V
V_{GE} = V_{CE}, I_C = 0.35 mA		4.5	5.5	6.5	
Collector-emitter saturation voltage	$V_{CE(sat)}$				
V_{GE} = 15 V, I_C = 15 A, T_j = 25 °C		-	2.7	3.2	
V_{GE} = 15 V, I_C = 15 A, T_j = 125 °C		-	3.3	3.9	
V_{GE} = 15 V, I_C = 30 A, T_j = 25 °C		-	3.4	-	
V_{GE} = 15 V, I_C = 30 A, T_j = 125 °C		-	4.3	-	
Zero gate voltage collector current	I_{CES}				mA
V_{CE} = 1200 V, V_{GE} = 0 V, T_j = 25 °C		-	-	0.8	
Gate-emitter leakage current	I_{GES}				nA
V_{GE} = 25 V, V_{CE} = 0 V		-	-	100	
AC Characteristics					
Transconductance	g_{fs}				S
V_{CE} = 20 V, I_C = 15 A		-	12	-	
Input capacitance	C_{iss}				pF
V_{CE} = 25 V, V_{GE} = 0 V, f = 1 MHz		-	1000	1350	
Output capacitance	C_{oss}				
V_{CE} = 25 V, V_{GE} = 0 V, f = 1 MHz		-	150	225	
Reverse transfer capacitance	C_{rss}				
V_{CE} = 25 V, V_{GE} = 0 V, f = 1 MHz		-	70	100	

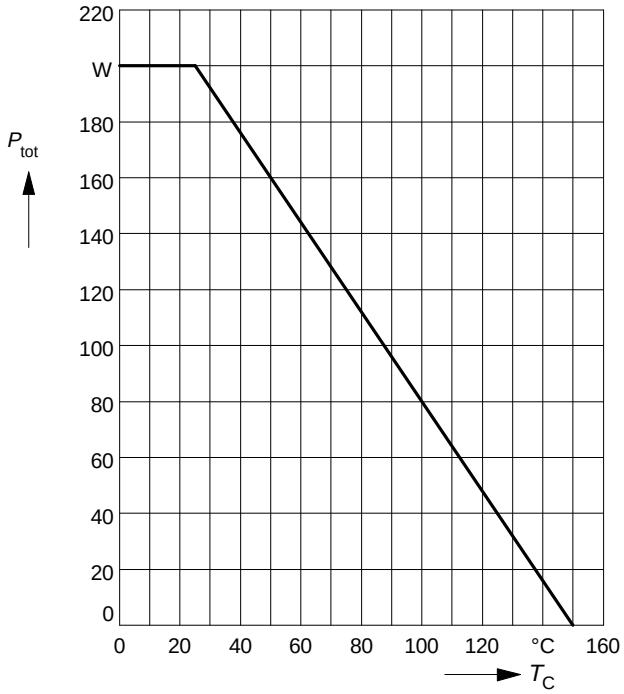
Electrical Characteristics, at T_j = 25 °C, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Switching Characteristics, Inductive Load at T_j = 125 °C					
Turn-on delay time V_{CC} = 600 V, V_{GE} = 15 V, I_C = 15 A R_{Gon} = 82 Ω	$t_{d(on)}$	-	70	100	ns
Rise time V_{CC} = 600 V, V_{GE} = 15 V, I_C = 15 A R_{Gon} = 82 Ω	t_r	-	45	70	
Turn-off delay time V_{CC} = 600 V, V_{GE} = -15 V, I_C = 15 A R_{Goff} = 82 Ω	$t_{d(off)}$	-	400	530	
Fall time V_{CC} = 600 V, V_{GE} = -15 V, I_C = 15 A R_{Goff} = 82 Ω	t_f	-	70	95	

Power dissipation

$P_{tot} = f(T_C)$

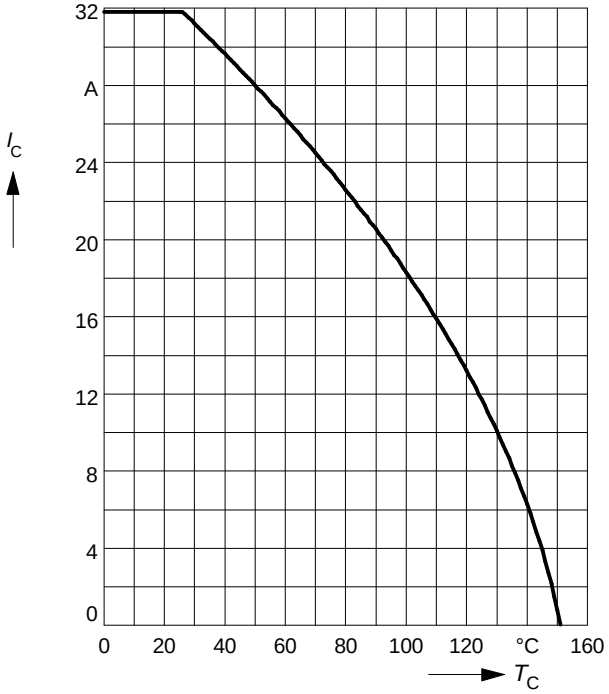
parameter: $T_j \leq 150$ °C



Collector current

$I_C = f(T_C)$

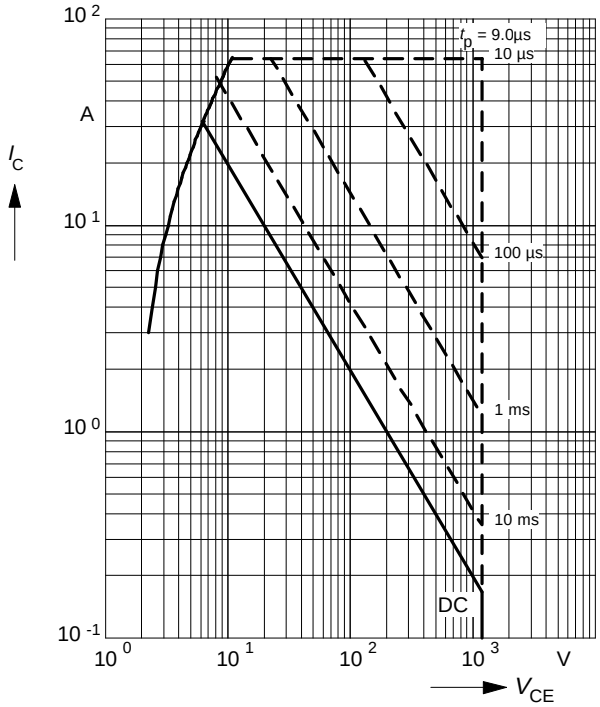
parameter: $V_{GE} \geq 15$ V , $T_j \leq 150$ °C



Safe operating area

$I_C = f(V_{CE})$

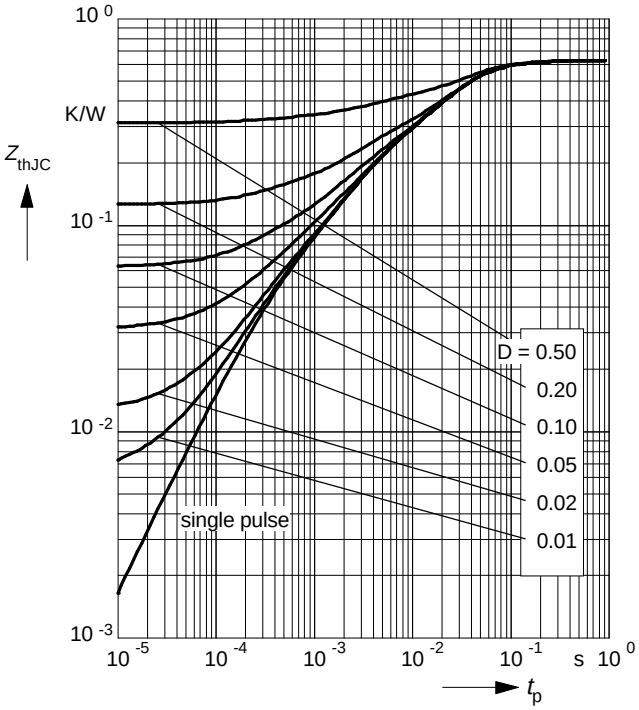
parameter: $D = 0$, $T_C = 25$°C , $T_j \leq 150$ °C



Transient thermal impedance IGBT

$Z_{th\,JC} = f(t_p)$

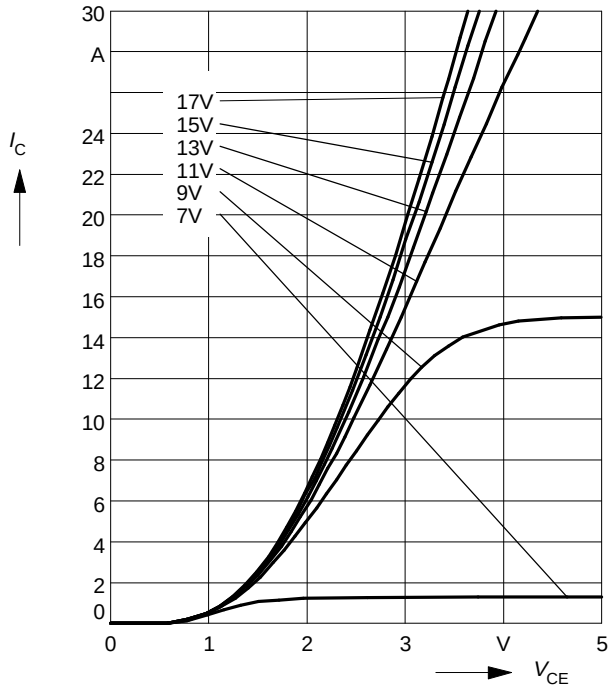
parameter: $D = t_p / T$



Typ. output characteristics

$I_C = f(V_{CE})$

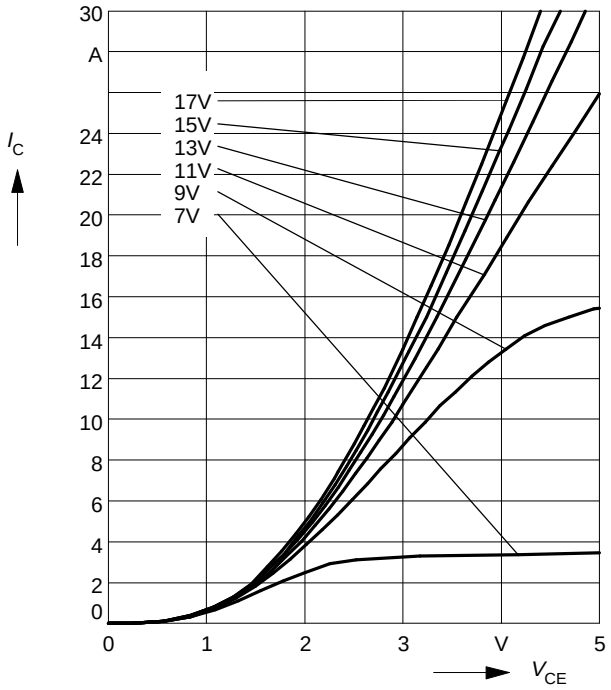
parameter: t_p = 80 µs, T_j = 25 °C



Typ. output characteristics

$I_C = f(V_{CE})$

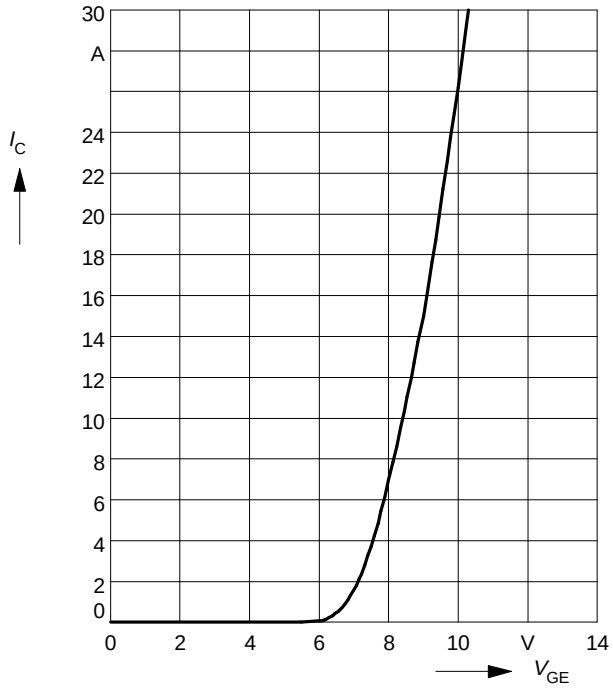
parameter: t_p = 80 µs, T_j = 125 °C



Typ. transfer characteristics

$I_C = f(V_{GE})$

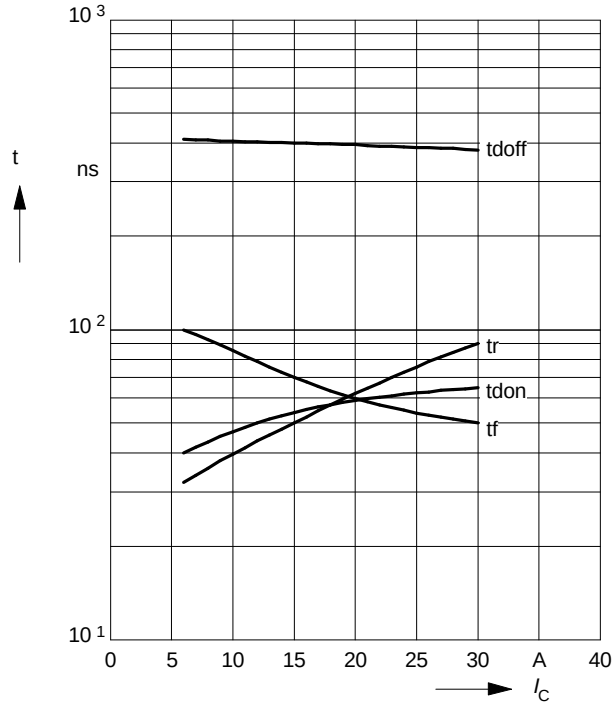
parameter: t_p = 80 µs, V_{CE} = 20 V



Typ. switching time

$I = f(I_C)$, inductive load , T_j = 125°C

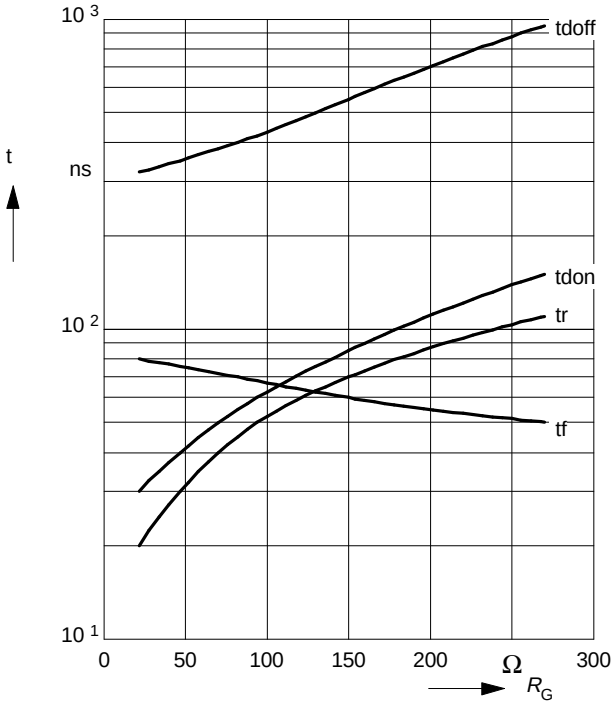
par.: V_{CE} = 600 V, V_{GE} = ± 15 V, R_G = 82 Ω



Typ. switching time

$t = f(R_G)$, inductive load , T_j = 125°C

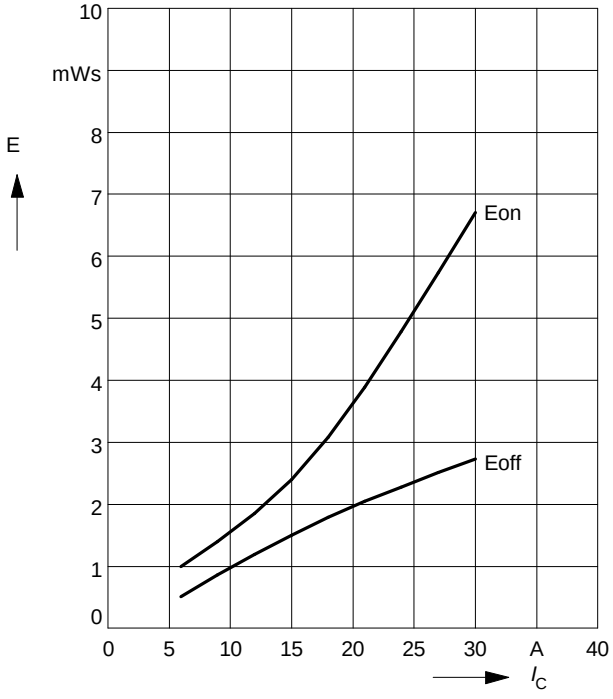
par.: V_{CE} = 600 V, V_{GE} = ± 15 V, I_C = 15 A



Typ. switching losses

$E = f(I_C)$, inductive load , T_j = 125°C

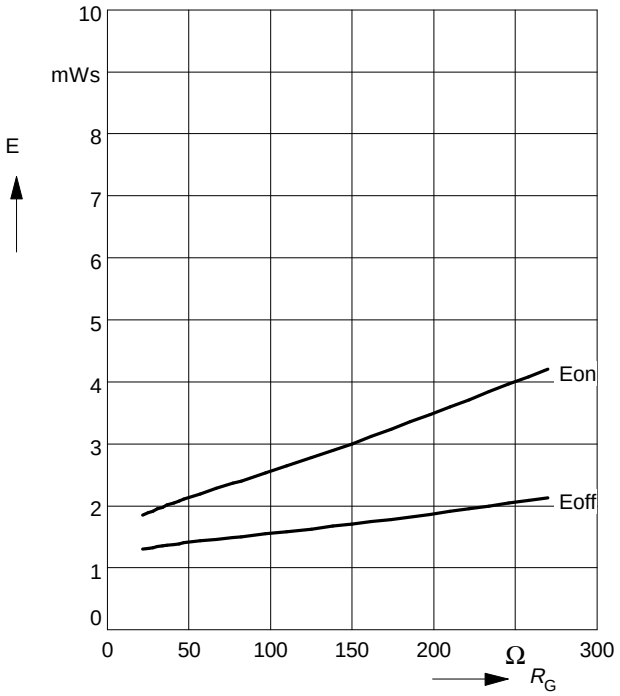
par.: V_{CE} = 600 V, V_{GE} = ± 15 V, R_G = 82 Ω



Typ. switching losses

$E = f(R_G)$, inductive load , T_j = 125°C

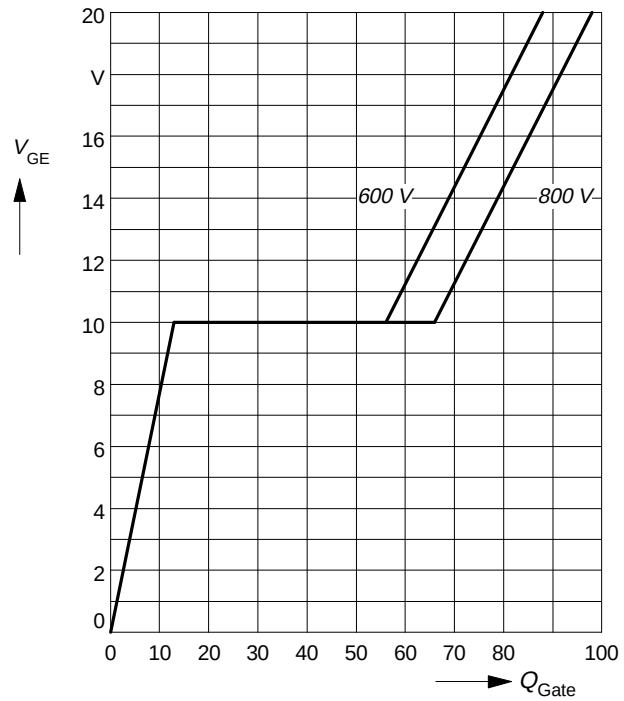
par.: V_{CE} = 600V, V_{GE} = ± 15 V, I_C = 15 A



Typ. gate charge

$V_{GE} = f(Q_{Gate})$

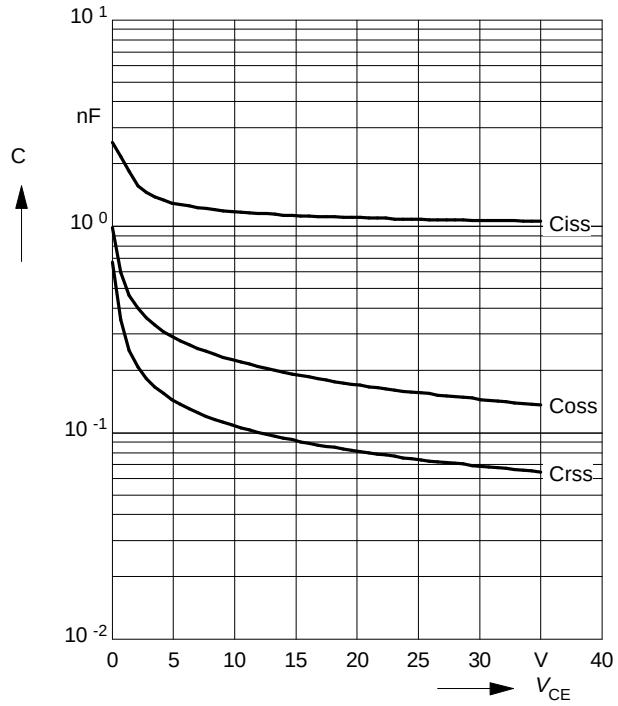
parameter: $I_{C\ puls}$ = 15 A



Typ. capacitances

$C = f(V_{CE})$

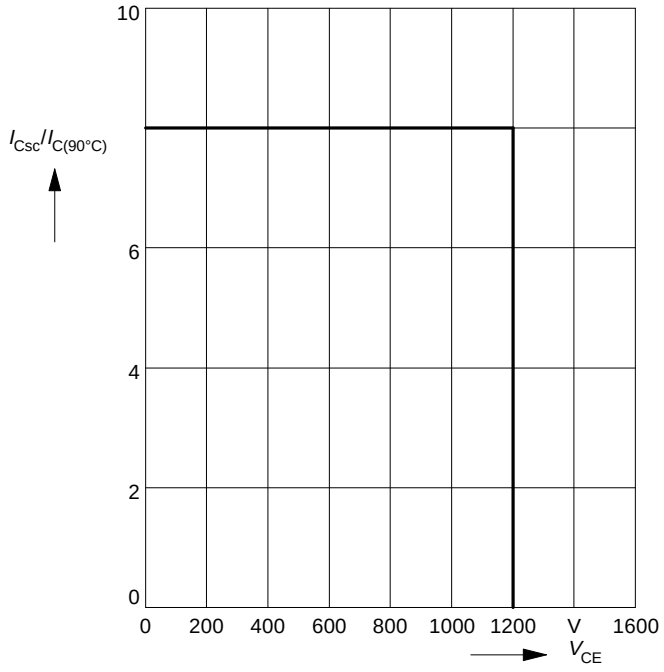
parameter: V_{GE} = 0 V, f = 1 MHz



Short circuit safe operating area

$I_{Csc} = f(V_{CE})$, T_j = 150°C

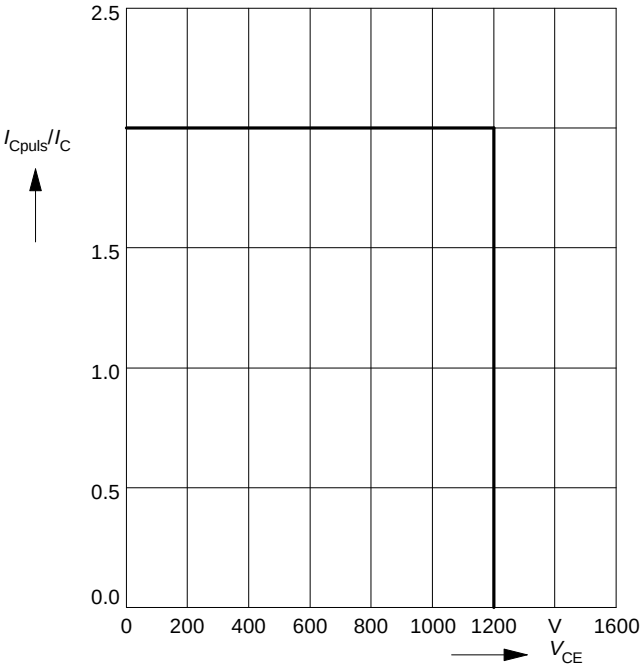
parameter: V_{GE} = ± 15 V, $t_{sc} \leq$ 10 µs, L < 25 nH



Reverse biased safe operating area

$I_{Cpuls} = f(V_{CE})$, T_j = 150°C

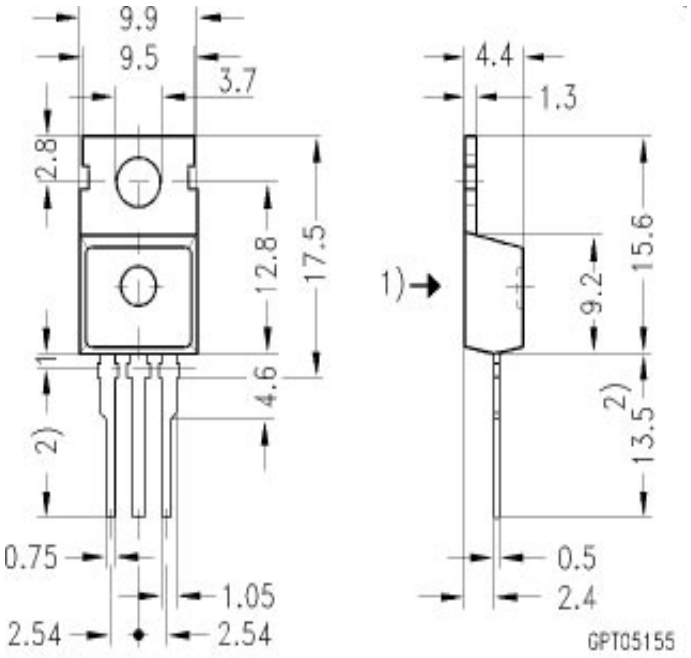
parameter: V_{GE} = 15 V



Package Outlines

Dimensions in mm

Weight:



1) punch direction, burr max. 0.04

2) dip tinning

3) max. 14.5 by dip tinning press burr max. 0.05

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